



P-CHANNEL ENHANCEMENT MODE MOSFET POWERDI®

Product Summary

V _{(BR)DSS}	$R_{DS(ON)}$ max $R_{DS(ON)}$ $T_{A} = +2$	
-30V	$13m\Omega @ V_{GS} = -10V$	-9.8A
	$25m\Omega$ @ $V_{GS} = -4.5V$	-7.0A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

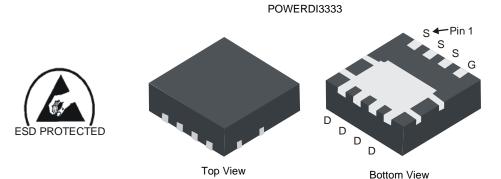
- Backlighting
- Power Management Functions
- DC-DC Converters

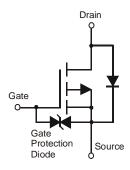
Features and Benefits

- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI3333
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 <a>(3)
- Weight: 0.0174 grams (approximate)





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMG7401SFG-7	POWERDI3333	2000/Tape & Reel
DMG7401SFG-13	POWERDI3333	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/packages.html

Marking Information



G75 = Product marking code YYWW = Date code marking YY = Last digit of year (ex: 10 for 2010) WW = Week code (01 – 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	-30	V		
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Prais Current (Note 6) // 40/	Steady State	T _A = +25°C T _A = +70°C	I _D	-9.8 -7.7	А
Continuous Drain Current (Note 6) V _{GS} = -10V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	-13.5 -10.8	А
Maximum Continuous Body Diode Forward Curren	I _S	-3.0	Α		
Pulsed Drain Current (10µs pulse, duty cycle = 1%	I _{DM}	-80	Α		
Avalanche Current (Notes 7 & 8)	I _{AR}	14	Α		
Repetitive Avalanche Energy (Notes 7 & 8) L = 1mH			E _{AR}	104	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Bower Dissipation (Note 5)	T _A = +25°C	D	0.94	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P _D	0.6	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	0	137	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	R _{0JA}	82	°C/W	
Total Dawer Dissination (Note 6)	$T_A = +25^{\circ}C$	0	2.2	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P _D	1.3		
Thermal Desistance Junation to Ambient (Note 6)	Steady State	0	60	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R _{0JA}	36	°C/W	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	3.0	°C/W	
Operating and Storage Temperature Range		T _{J.} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

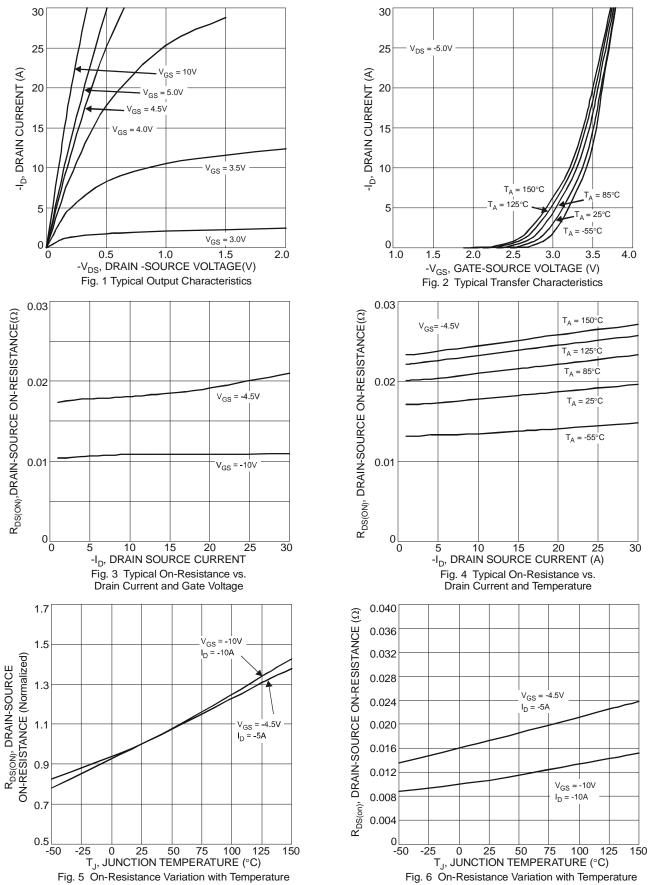
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_		V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}			-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(th)}$	-1.7	_	-3.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		l	9	11	mΩ	$V_{GS} = -20V, I_D = -12A$	
Static Drain-Source On-Resistance	R _{DS} (ON)		10	13		$V_{GS} = -10V, I_D = -9A$	
		1	17	25		$V_{GS} = -4.5V, I_D = -5A$	
Forward Transfer Admittance	Y _{fs}		21		S	$V_{DS} = -5V, I_{D} = -10A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	l	2246	2987	pF	15)/ 15)/)/	
Output Capacitance	Coss	l	352	468	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss		294	391	pF	1 = 1.0WH IZ	
Gate resistance	R_g		5.1	8.5	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	1	20.5	30	nC		
Total Gate Charge (V _{GS} = 10V)	Q_g		41	58	nC	V 45V L 42A	
Gate-Source Charge	Q_{gs}	_	7.6	-	nC	$V_{DS} = -15V, I_D = -12A$	
Gate-Drain Charge	Q_{gd}	_	8.0	-	nC		
Turn-On Delay Time	t _{D(on)}	_	11.3	23	ns		
Turn-On Rise Time	t _r	_	15.4	31	ns	$V_{DD} = -15V, V_{GS} = -10V,$	
Turn-Off Delay Time	t _{D(off)}	_	38.0	61	ns	$R_L = 1.25\Omega$, $R_G = 3\Omega$,	
Turn-Off Fall Time	t _f		22.0	38	ns		
BODY DIODE CHARACTERISTICS							
Diode Forward Voltage	V_{SD}	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
Reverse Recovery Time (Note 9)	t _{rr}		20	31	ns	1- 0.50 dl/dt 1000/:	
Reverse Recovery Charge (Note 9)	Q _{rr}	_	9.5	18	nC	$I_S = -9.5A$, $dI/dt = 100A/\mu s$	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$ Notes:

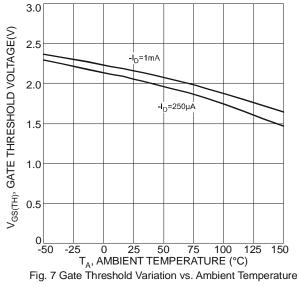
8. Short duration pulse test used to minimize self-heating effect

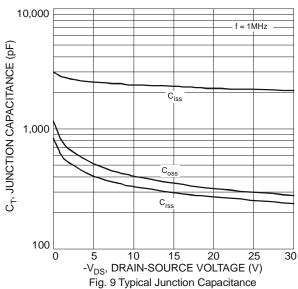
9. Guaranteed by design. Not subject to product testing

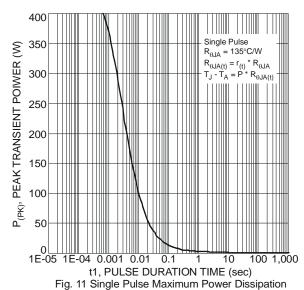


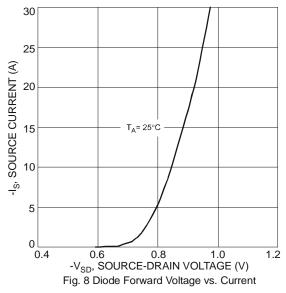


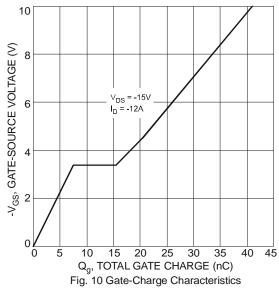


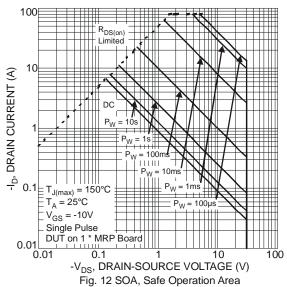




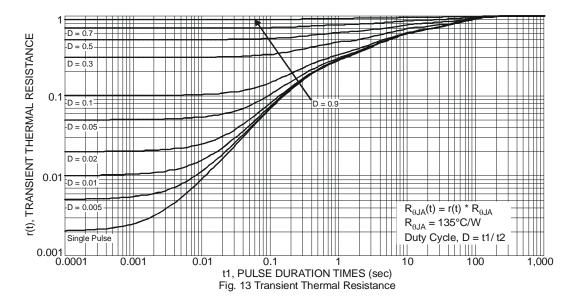






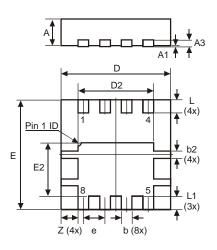






Package Outline Dimensions

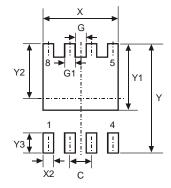
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI3333-8						
Dim	Min	Max	Тур			
D	3.25	3.35	3.30			
Е	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
E2	1.56	1.66	1.61			
Α	0.75	0.85	0.80			
A1	0	0.05	0.02			
A3	1	_	0.203			
b	0.27	0.37	0.32			
b2	1	_	0.20			
L	0.35	0.45	0.40			
L1	-	_	0.39			
е	_	_	0.65			
Z	_	_	0.515			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	0.230			
G1	0.420			
Υ	3.700			
Y1	2.250			
Y2	1.850			
Y3	0.700			
Х	2.370			
X2	0.420			



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